



## DZ23C2V7 - DZ23C51

### 300mW DUAL SURFACE MOUNT ZENER DIODE

### **Features**

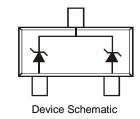
- Dual Zeners in Common Cathode Configuration
- 300mW Power Dissipation
- Ideally Suited for Automated Insertion
- $\Delta V_Z$  For Both Diodes in One Case is  $\leq 5\%$
- Common Anode Style Available, See AZ Series
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

## **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Lead Frame (Lead Free Plating). Solderable per MIL-STD-202, Method 208 🕄
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)

SOT23

Top View



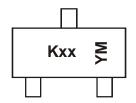
## Ordering Information (Notes 5 and 6)

Part Number	Qualification	Packaging	Shipping
(Type Number)-7-F*	Commercial	SOT23	3000/Tape & Reel
(Type Number)Q-7-F*	Automotive	SOT23	3000/Tape & Reel

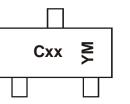
\*Add "-7-F" to the appropriate type number in Electrical Characteristics Table on Page 2. Example: 6.2V Zener = DZ23C6V2-7-F.

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  - 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  - 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
  - 5. Product manufactured with Date Code OW (week 42, 2009) and newer are built with Green Molding Compound. Product manufactured prior to Date
  - Code OW are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants. 6. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



K = SAT (Shanghai Assembly / Test Site)
xx = Product Type Marking Code
See Electrical Characteristics Table
YM = Date Code Marking
Y = Year (ex: G = 2019)
M = Month (ex: 9 = September)



C = CAT (Chengdu Assembly / Test Site) xx = Product Type Marking Code See Electrical Characteristics Table YM = Date Code Marking Y = Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Code Key

Notes:

Year	2013	2014	2015	2016	201	7 20	18 2	019	2020	2021	2022	2023
Code	А	В	С	D	E	F	-	G	Н	I	J	K
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



## **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 7)	PD	300	mW
Thermal Resistance, Junction to Ambient Air	(Note 7)	R <sub>θJA</sub>	417	°C/W
Operating and Storage Temperature Range		TJ, T <sub>STG</sub>	-65 to +150	С

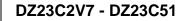
Note: 7. Mounted on FR4 PC Board with recommended pad layout which can be found on our website at http://www.diodes.com.

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Type Marking		ZenerMaximumVoltage RangeZener Impedance(Note 8)f = 1kHz			Typical Temperature Coefficient	Minimum Reverse Voltage (Note 8)
Number	Code	@ I <sub>ZT</sub> = 5.0mA	Z <sub>ZT</sub> @ I <sub>ZT</sub> = 5.0mA	Z <sub>ZK</sub> @ I <sub>ZK</sub> = 1.0mA	Coemcient	@ I <sub>R</sub> = 0.1µA
		V <sub>Z</sub> (V)	Ω	Ω	TC (%/°C)	V <sub>R</sub> (V)
DZ23C2V7	V1	2.5 to 2.9	83	500	-0.065	_
DZ23C3V0	V2	2.8 to 3.2	95	500	-0.060	—
DZ23C3V3	V3	3.1 to 3.5	95	500	-0.055	_
DZ23C3V6	V4	3.4 to 3.8	95	500	-0.055	_
DZ23C3V9	V5	3.7 to 4.1	95	500	-0.050	_
DZ23C4V3	V6	4.0 to 4.6	95	500	-0.035	_
DZ23C4V7	V7	4.4 to 5.0	78	500	-0.015	—
DZ23C5V1	V8	4.8 to 5.4	60	480	+0.005	0.8
DZ23C5V6	V9	5.2 to 6.0	40	400	+0.020	1.0
DZ23C6V2	VA	5.8 to 6.6	10	200	+0.030	2.0
DZ23C6V8	VB	6.4 to 7.2	8.0	150	+0.045	3.0
DZ23C7V5	VC	7.0 to 7.9	7.0	50	+0.050	5.0
DZ23C8V2	VD	7.7 to 8.7	7.0	50	+0.055	6.0
DZ23C9V1	VE	8.5 to 9.6	10	50	+0.065	7.0
DZ23C10	VF	9.4 to 10.6	15	70	+0.065	7.5
DZ23C11	VG	10.4 to 11.6	20	70	+0.070	8.5
DZ23C12	VH	11.4 to 12.7	20	90	+0.075	9.0
DZ23C13	VI	12.4 to 14.1	25	110	+0.080	10.0
DZ23C15	VJ	13.8 to 15.6	30	110	+0.080	11.0
DZ23C16	VK	15.3 to 17.1	40	170	+0.090	12.0
DZ23C18	VL	16.8 to 19.1	50	170	+0.090	14.0
DZ23C20	VM	18.8 to 21.2	50	220	+0.090	15.0
DZ23C22	VN	20.8 to 23.3	55	220	+0.090	17.0
DZ23C24	VO	22.8 to 25.6	80	220	+0.090	18.0
DZ23C27	VP	25.1 to 28.9	80	250	+0.090	20.0
DZ23C30	VQ	28 to 32	80	250	+0.090	22.5
DZ23C33	VR	31 to 35	80	250	+0.090	25.0
DZ23C36	VS	34 to 38	90	250	+0.090	27.0
DZ23C39	VT	37 to 41	90	300	+0.110	29.0
DZ23C43	VU	40 to 46	100	700	+0.110	32.0
DZ23C47	VV	44 to 50	100	750	+0.110	35.0
DZ23C51	VW	48 to 54	100	750	+0.110	38.0

Note: 8. Short duration pulse test used to minimize self-heating effect.





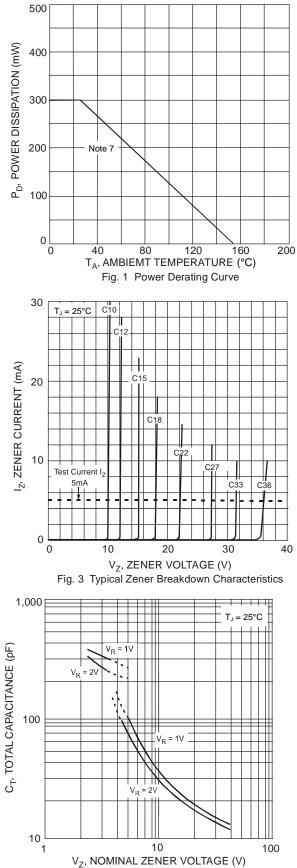
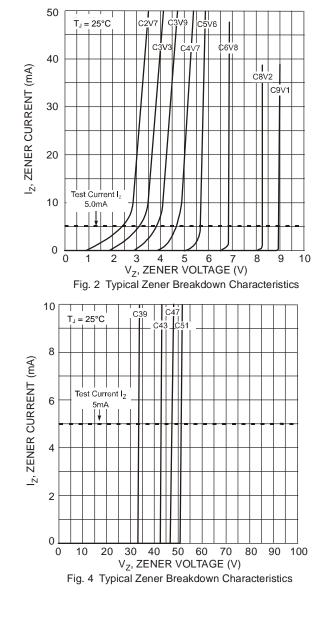


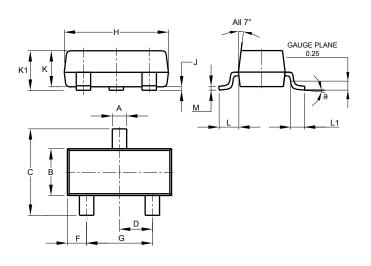
Fig. 5 Typical Total Capacitance vs. Nominal Zener Voltage





# Package Outline Dimensions

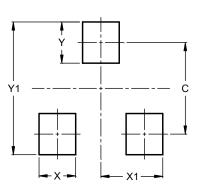
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
М	0.085	0.150	0.110			
а	0°	8°				
All	All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

SOT23

Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9

e Dimensions



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